## 503570424 11/16/2015

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

sion v1.1 EPAS ID: PAT3617051

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WILLIAM L. BRODSKY	11/02/2015
JAMES A. BUSBY	11/02/2015
ZACHARY T. DREISS	11/05/2015
MICHAEL J. FISHER	11/02/2015
DAVID C. LONG	11/05/2015
WILLIAM SANTIAGO-FERNANDEZ	10/30/2015
THOMAS WEISS	10/30/2015

#### **RECEIVING PARTY DATA**

Name:	INTERNATIONAL BUSINESS MACHINES CORPORATION
Street Address:	NEW ORCHARD ROAD
City:	ARMONK
State/Country:	NEW YORK
Postal Code:	10504

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14941860

### **CORRESPONDENCE DATA**

**Fax Number:** (518)452-5579

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: KEVIN P. RADIGAN, ESQ.

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ATTORNEY DOCKET NUMBER:	POU920150318US2
NAME OF SUBMITTER:	KEVIN P. RADIGAN, ESQ.
SIGNATURE:	/Kevin P. Radigan, Esq./
DATE SIGNED:	11/16/2015

	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 21	
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Title of Invention:

#### TAMPER-RESPONDENT ASSEMBLIES WITH BOND PROTECTION

As a below named and undersigned inventor, I hereby declare that:

This declaration is directed to the attached application, or (if following box is checked):

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I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1) Legal Name of Inventor: William L. BRODSKY

Signature: William L Brooks	Date: 2 Nov 7	2015
(2) Legal Name of Inventor: James A. BUSBY		
Signature:	Date:	
(3) Legal Name of Inventor: <b>Zachary T. DREI</b> S	SS	
Signature:	Date:	
(4) Legal Name of Inventor: Michael J. FISHE	CR	
Signature:	Date:	
(5) Legal Name of Inventor: David C. LONG		
Signature:	Date:	

(6) Legal Name of Inventor: William SANTIAGO-	FERNANDEZ
Signature:	Date:
(7) Legal Name of Inventor: <b>Thomas WEISS</b>	
Signature:	Date:

# DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention:

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(1) Legal Name of Inventor. William L. BRODSKY	
Signature:	Date
(2) Legal Name of Inventor: James A. BUSBY	
Signature A. Dost (3) Legal Name of Inventor. Zachary T. DREISS	Date. 11 02 2015
Signature	Date
(4) Legal Name of Inventor. Michael J. FISHER	
Signature	Date
(5) Legal Name of Inventor: <b>David C. LONG</b>	
Signaturo:	Date

(6) Legal Name of Inventor. Willi	am SANTIAGO-FERNANDEZ	
Signature	Date	
(7) Legal Name of Inventor: <b>Thor</b>	nas WEISS	
Signature	Date:	

Title of Invention:

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(1) Legal Name of Inventor: William L. BRODSKY	•
Signature:	Date:
(2) Legal Name of Inventor: James A. BUSBY	
Signature:	Date:
(3) Legal Name of Inventor: Zachary T. DREISS	
Signature:	Date: 11/5/2015
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Signature:	Date:
(5) Legal Name of Inventor: David C. LONG	
Signature:	Date:

(6) Legal Name of Inventor: William SANT	TAGO-FERNANDEZ
Signature:	Date:
(7) Legal Name of Inventor: <b>Thomas WEIS</b>	S
Signature:	Date:

Title of Invention:

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Signature:	Date:	_
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Signature: Mallf	Date: 11/2/15	e na el commissión de la commissión de l
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Signature: O-C-C3	Date: 11-5-2015

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Signature: Willer And And		
$\mathcal{C}$		
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Signature:	Date:	

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Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in the ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by the ASSIGNEE, its successors, legal representatives, or assigns.

I acknowledge my prior and ongoing obligations to sell, assign, and transfer my rights under this Assignment to the ASSIGNEE and am unaware of any reason why I may not have the full and unencumbered right to sell, assign, and transfer my rights hereby sold, assigned, and transferred, and have not executed, and will not execute, any document or instrument in conflict herewith. I also hereby grant the ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

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Signature:	Date:
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Page 3 of 3

PATENT REEL: 037112 FRAME: 0692

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